



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _A = +25°C
-30V	$90m\Omega$ @ $V_{GS} = -10V$	-3.3A
	134mΩ @ V _{GS} = -4.5V	-2.5A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions

Features

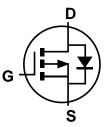
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

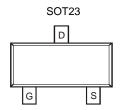
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)







Internal Schematic



Top View

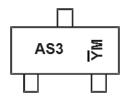
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3165L-7	SOT23	3000/Tape & Reel
DMP3165L-13	SOT23	10000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



AS3 = Product Type Marking Code $\overline{Y}M$ = Date Code Marking \overline{Y} = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2017	2018	20	019	2020	2021		2022	2023	202	24	2025
Code	Е	F		G	Н	- 1		J	K	L		M
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

DMP3165L 1 of 7
Document number: DS40415 Rev. 2 - 2 Downloaded From Oneyac.com



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Character	istic		Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±20	V
Drain Current (Note 6) $V_{GS} = -10V$ Steady $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		I _D	-3.3 -2.7	А	
Pulsed Drain Current (380µs Pulse, D	outy Cycle = 1	%)	I _{DM}	-13	А

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	0.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	159	°C/W
Total Power Dissipation (Note 6)		P _D	1.3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	98	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

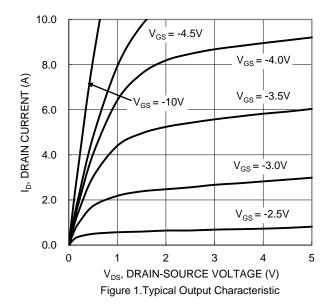
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-800	nA	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±80 ±800	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$ $V_{GS} = \pm 15V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-1.3	_	-2.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance	D		59	90	mΩ	$V_{GS} = -10V, I_D = -2.7A$	
Static Diam-Source On-Nesistance	R _{DS(ON)}	_	100	134	11122	$V_{GS} = -4.5V$, $I_{D} = -2.0A$	
Diode Forward Voltage	V _{SD}	_	-0.83	-1.26	V	$V_{GS} = 0V$, $I_{S} = -2.7A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	300		pF	.,	
Output Capacitance	Coss	_	52		pF	$V_{DS} = -10V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	35		pF	1 - 1.01/11/12	
Gate Resistance	R _G	_	12.5		Ω	$V_{GS} = 0V$, $V_{DS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	1.0	_	nC		
Total Gate Charge (V _{GS} = -10V)	Qg	_	2.0		nC	$V_{GS} = -10V/-4.5V$,	
Gate-Source Charge	Qgs	_	0.2		nC	$V_{DS} = -15V, I_{D} = -3A$	
Gate-Drain Charge	Q _{gd}	_	0.5	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	3.7		ns		
Turn-On Rise Time	t _R	_	5.5		ns	$V_{DS} = -15V, V_{GS} = -10V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	13.6	_	ns	$R_G = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	t _F	_	8.4		ns		
Reverse Recovery Time	t _{RR}	_	6.5		ns	$I_F = -1.0A$, $di/dt = 100A/\mu s$	
Reverse Recovery Charge	Q _{RR}	_	1.2	_	nC	$I_F = -1.0A$, $di/dt = 100A/\mu s$	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect. Notes:

8. Guaranteed by design. Not subject to product testing.

2 of 7 DMP3165L February 2018 Document number: DS40415 Rev. 2 - 2 Downloaded From Oneyac.com





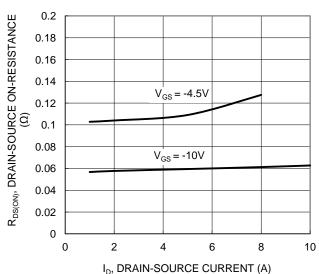


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

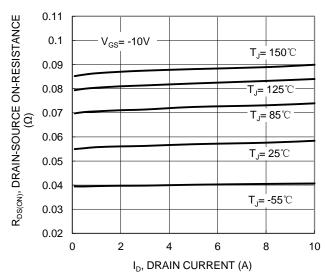
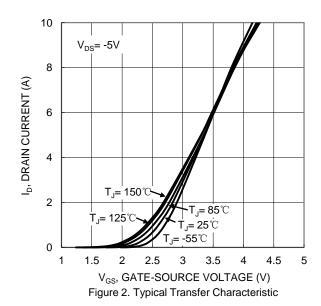
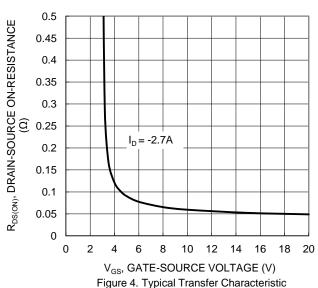


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





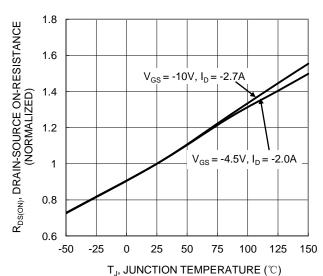


Figure 6. On-Resistance Variation with Temperature



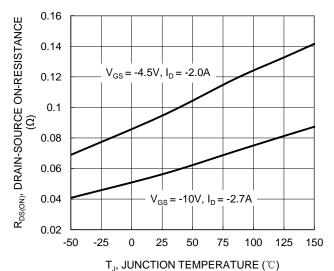


Figure 7. On-Resistance Variation with Temperature

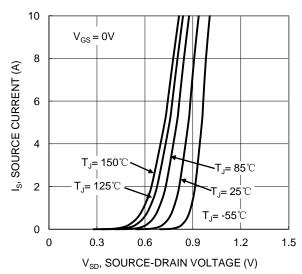
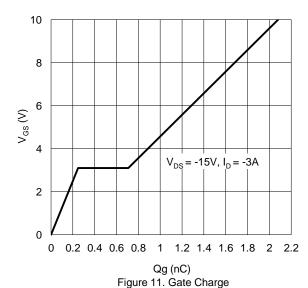
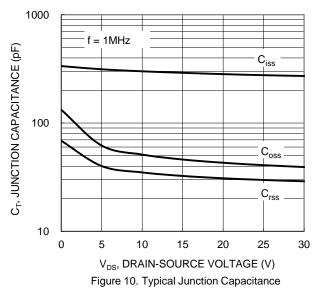


Figure 9. Diode Forward Voltage vs. Current



2 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) 1.8 $I_D = -1mA$ 1.6 $I_{D} = -250 \mu A$ 1.4 1.2 -50 -25 0 25 50 75 100 125 150

T., JUNCTION TEMPERATURE (°C) Figure 8. Gate Threshold Variation vs. **JunctionTemperature**



100 R_{DS(ON)} LIMITED 10 ID, DRAIN CURRENT (A) 1 P_W=10ms T_{J(MAX)}=150℃ $T_{\rm C}$ =25 $^{\circ}$ C Single Pulse DUT on 1*MRP board 0.01 0.1 100 10 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



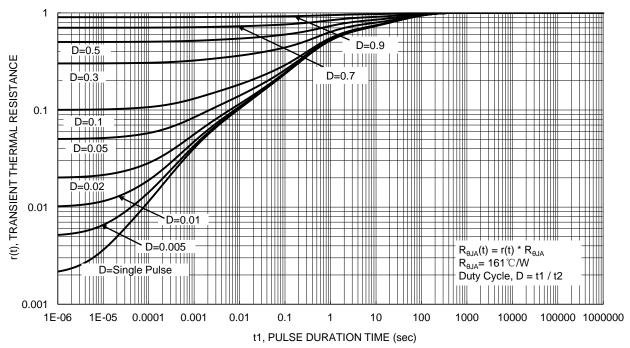


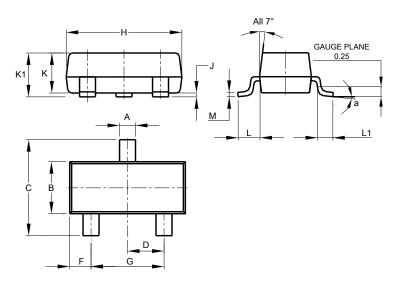
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

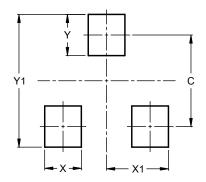


	SOT23						
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	a 0° 8°						
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)				
С	2.0				
Х	0.8				
X1	1.35				
Y	0.9				
Y1	2.9				



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